

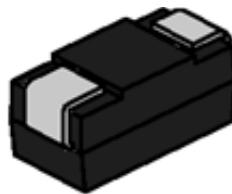


SM1K Series Transient Voltage Suppressor

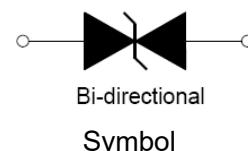
Rev.4.3

FEATURES:

- ✧ Excellent clamping capability.
- ✧ Low profile package and low inductance.
- ✧ High peak pulse current at 8/20 μ s waveform.
- ✧ Fast response time: typically less than 1.0ps from 0V to V_{BR} min.
- ✧ High temperature soldering: 260°C/40s at terminals.
- ✧ Plastic package has underwriters laboratory flammability 94V-0.
- ✧ Meets MSL level 1, per J-STD-020, LF maximum peak of 260°C.
- ✧ Terminal: solder plated, solderable per J-STD-002.
- ✧ For surface mounted applications in order to optimize board space.
- ✧ UL 497B item recognized. (File No.: E480698).
- ✧ IEC61000-4-2 (ESD) $\pm 30kV$ (air), $\pm 30kV$ (contact).

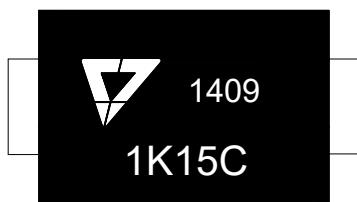


SMB

Bi-directional
SymbolABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ C$, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Storage temperature range	T_{STG}	-55 to +150	°C
Operating junction temperature range	T_J	-55 to +150	°C
Steady state power dissipation at $T_L=75^\circ C$	$P_{M(AV)}$	5.0	W
Peak pulse current at 8/20 μ s waveform	I_{PP}	1000	A

MARKING



1K15C : Device Marking Code
1409: In ninth week, 2014

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$)

Part Number	Marking Code	V_R	$I_{R@V_R}$	$V_{BR}@I_T$		I_T	V_H^\ominus	$V_c@I_{PP}$	I_{PP}^\ominus
Bi-Polar		V	max(μA)	min(V)	max(V)	mA	typ(V)	max(V)	A
SM1K15C	1K15C	15	1	16.7	18.5	1	NA	32	1000
SM1K16C	1K16C	16	1	17.8	19.7	1	NA	34	1000
★SM1K18C	1K18C	18	1	20.0	22.3	1	18	37	1000
★SM1K20C	1K20C	20	1	22.0	24.5	1	19	40	1000

① Surge waveform: 8/20μs

V_R : Stand-off voltage -- Maximum voltage that can be applied

V_{BR} : Breakdown voltage

V_c : Clamping voltage -- Peak voltage measured across the suppressor at a specified I_{PP}

I_R : Reverse leakage current

★: Products with negative resistance

ORDERING INFORMATION

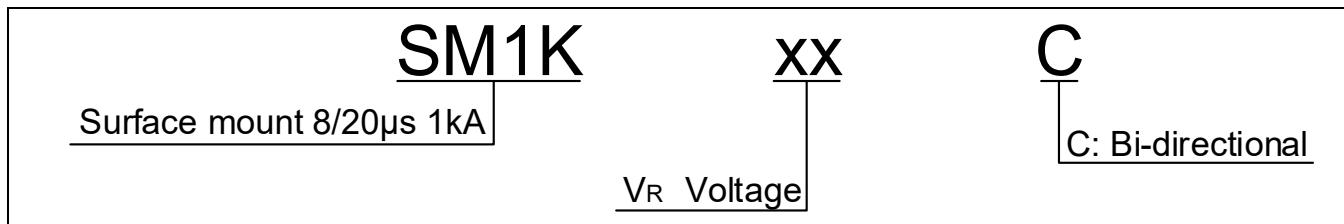
RATINGS AND V-I CHARACTERISTICS CURVES ($T_A=25^\circ\text{C}$, unless otherwise noted)

FIG.1:V- I curve characteristics
(Bi-directional)

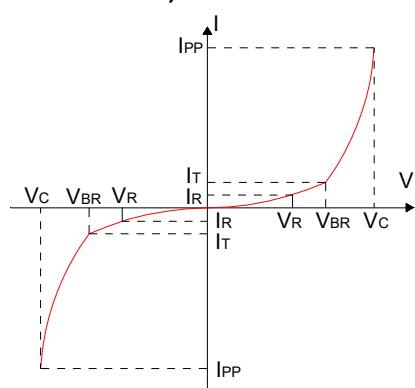


FIG.2:V- I curve characteristics
(Bi-directional with negative resistance)

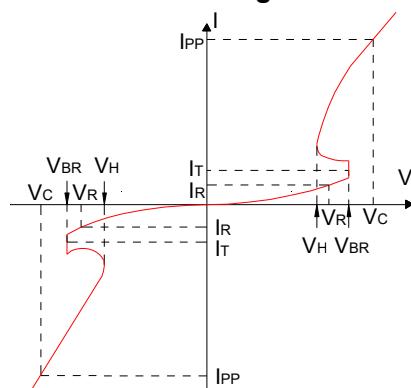


FIG.3: Pulse waveform

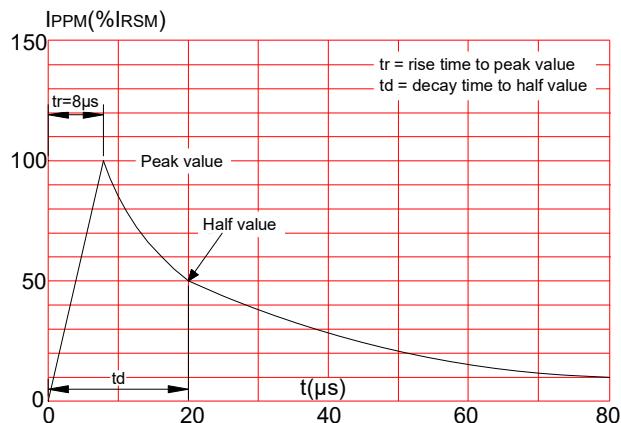
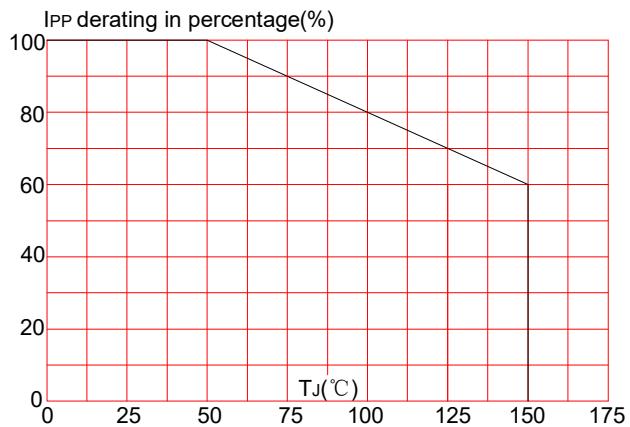
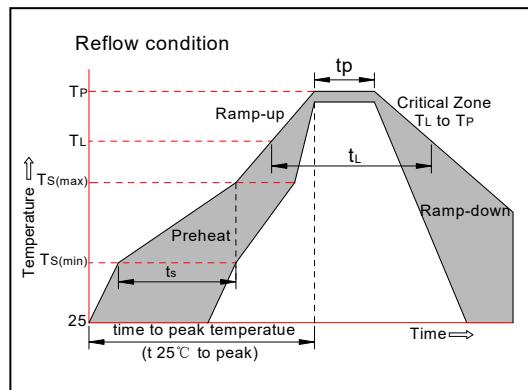


FIG.4: Pulse derating curve

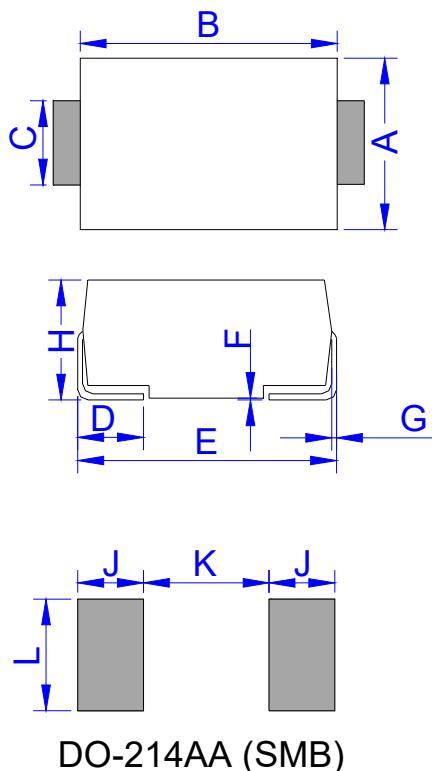


SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see figure at right)
Pre Heat	-Temperature Min ($T_{s(\min)}$)	+150°C
	-Temperature Max($T_{s(\max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L)to peak)		3°C/sec. Max
$T_{s(\max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquidus)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		20-40secs.
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_p)		8 min. Max
Do not exceed		+260°C

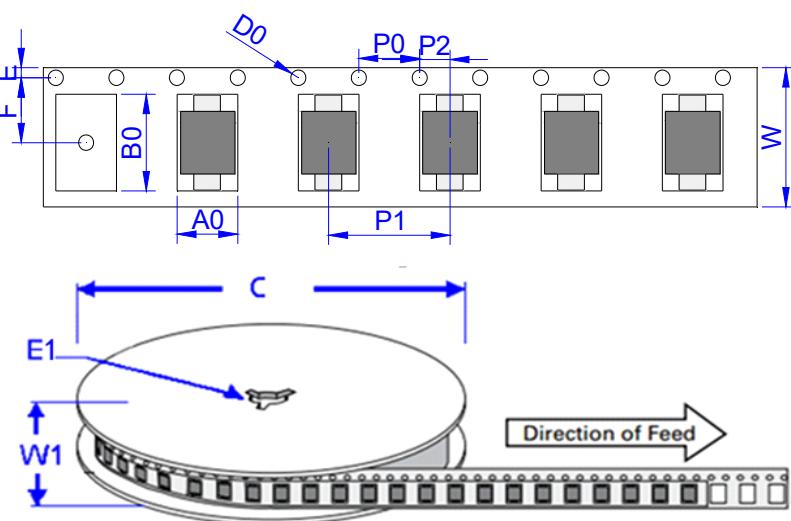


PACKAGE MECHANICAL DATA



Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	3.30	3.94	0.130	0.155
B	4.30	4.80	0.169	0.189
C	1.90	2.20	0.075	0.087
D	0.95	1.52	0.037	0.060
E	5.20	5.60	0.205	0.220
F	0.051	0.203	0.002	0.008
G	0.15	0.31	0.006	0.012
H	2.10	2.40	0.083	0.094
J	2.20		0.087	
K		2.60		0.102
L	2.30		0.091	

TAPE AND REEL SPECIFICATION-SMB



Ref.	Dimensions	
	Millimeters	Inches
A0	3.76 ± 0.3	0.148 ± 0.012
B0	5.69 ± 0.3	0.224 ± 0.012
C	330.0	13.0
D0	1.55 ± 0.1	0.061 ± 0.004
E	1.75 ± 0.2	0.069 ± 0.008
E1	13.3 ± 0.3	0.524 ± 0.012
F	5.5 ± 0.2	0.217 ± 0.008
P0	4.00 ± 0.2	0.157 ± 0.008
P1	8.00 ± 0.2	0.3145 ± 0.008
P2	2.00 ± 0.2	0.079 ± 0.008
W	12.0 ± 0.2	0.472 ± 0.008
W1	15.7 ± 2.0	0.618 ± 0.079

PART No.	UNIT WEIGHT (g/PCS) typ.	REEL (PCS)	PER CARTON (PCS)	DESCRIPTION
SM1KxxC	0.098	3,000	48,000	13 inch reel pack

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